HIMACHAL PRADESH INFRASTRUCTURE DEVELOPMENT BOARD (GOVT. OF HIMACHAL PRADESH)

EOI (Expression of Interest) for the Empanelment of Merchant Bankers-cum-Arrangers -cum- Advisors to facilitate the issuance of bonds/raising loan by Designate PSUs/ Organizations of HP Government.

Corrigendum-I dated 11.09.2025

In continuation to the earlier issued EOI on 26.08.2025, it is informed that the proposal due date has now been extended from 15.09.2025 to 22.09.2025 upto 1600 HRS

For further information, please contact

The Chief General Manager

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